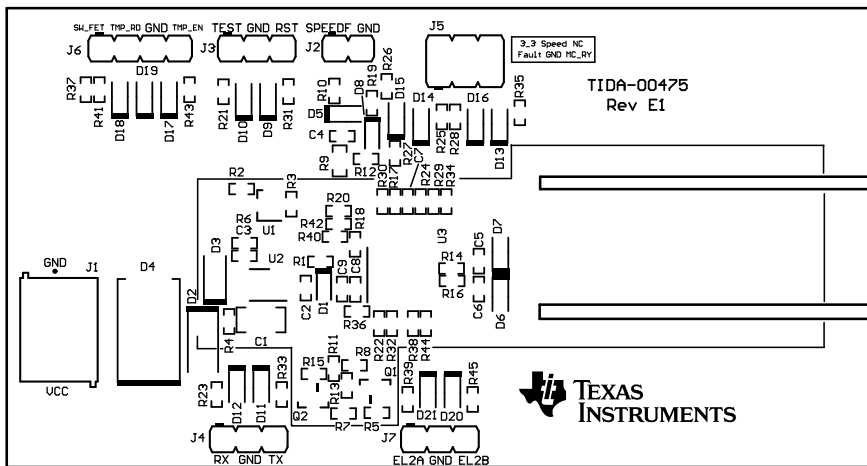
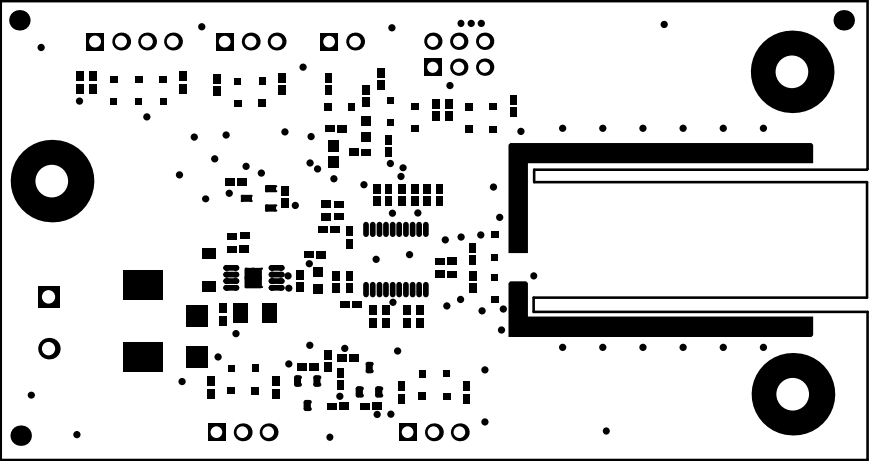
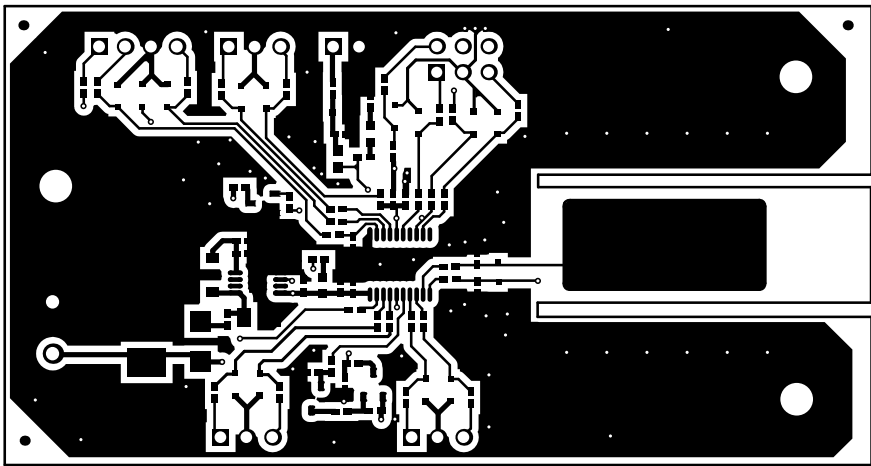




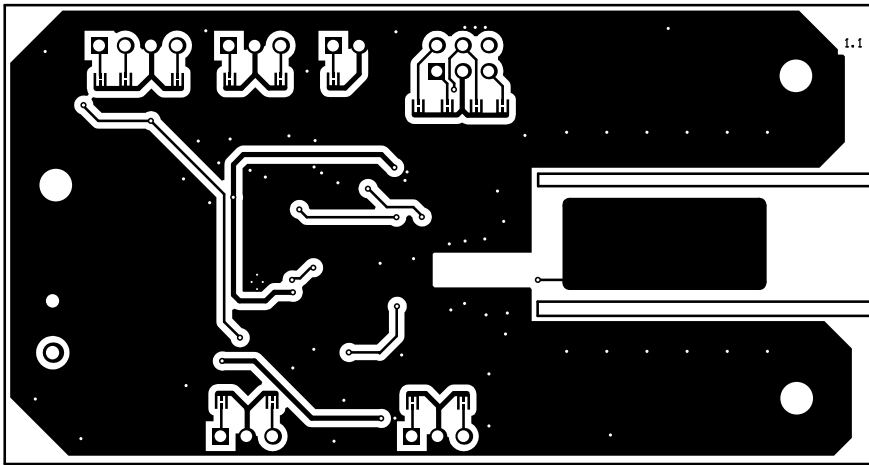
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: 475		
PLOT NAME = Top Overlay	GENERATED : 12/11/2015 8:16:50 PM		TEXAS INSTRUMENTS



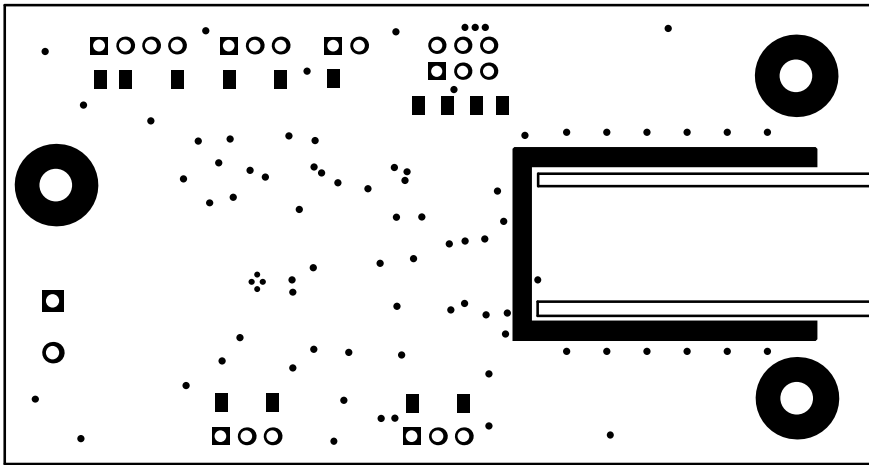
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 475		
PLOT NAME = Top Solder Mask	GENERATED : 12/11/2015 8:16:51 PM		TEXAS INSTRUMENTS



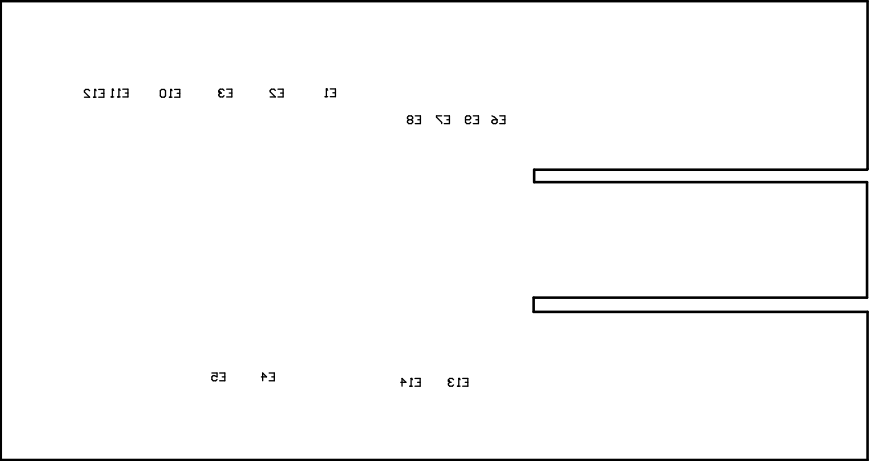
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 475		
PLOT NAME = Top Layer	GENERATED : 12/11/2015 8:16:52 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 475		
PLOT NAME = Bottom Layer	GENERATED : 12/11/2015 8:16:53 PM		TEXAS INSTRUMENTS

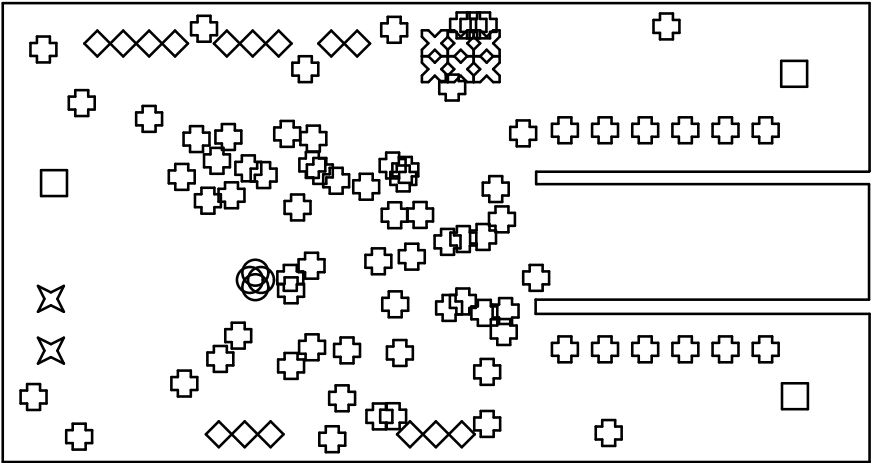


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 475		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/11/2015 8:16:53 PM		TEXAS INSTRUMENTS

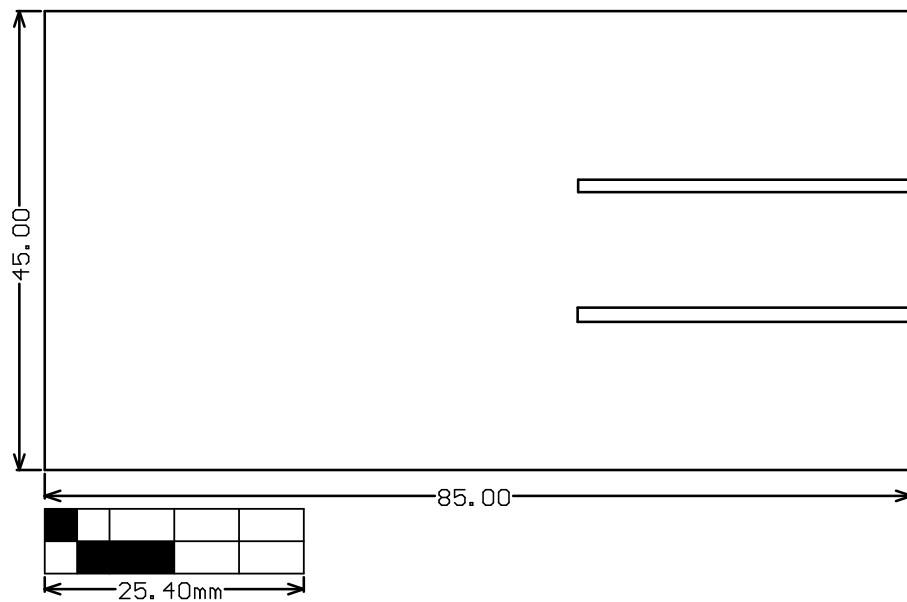


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 475		
PLOT NAME = Bottom Overlay	GENERATED : 12/11/2015 8:16:54 PM		TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	4	7.87mil (0.200mm)	PTH	Round
⊕	77	12.00mil (0.305mm)	PTH	Round
⊗	6	43.31mil (1.100mm)	PTH	Round
◇	15	45.28mil (1.150mm)	PTH	Round
✕	2	51.18mil (1.300mm)	PTH	Round
□	3	125.98mil (3.200mm)	PTH	Round
	107 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 475		
PLOT NAME = Drill Drawing	GENERATED : 12/11/2015 8:16:55 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00475	REV: 1.1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 475		
PLOT NAME = Board Dimensions	GENERATED : 12/11/2015 8:16:56 PM		TEXAS INSTRUMENTS

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